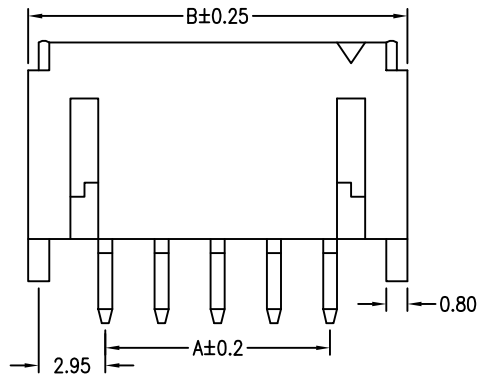


1 2 3 4 5 6 7

A

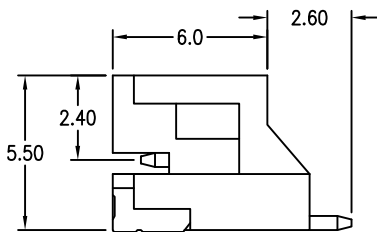
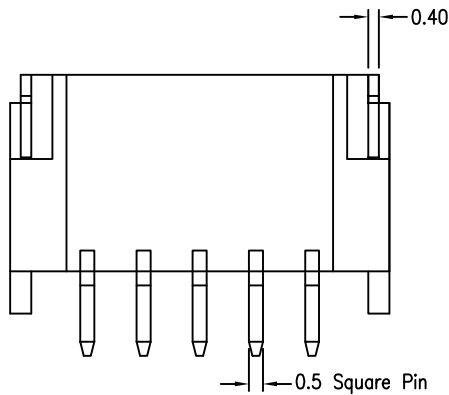


*** Material**

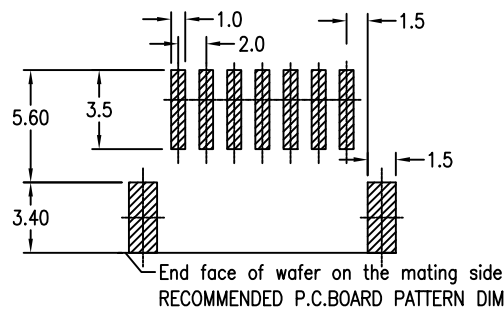
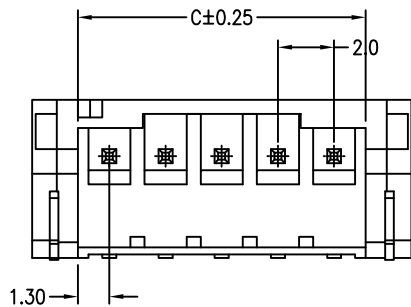
Wafer: High Temperature Plastic Nylon 46 UL94V-0
 Pin: High Strength Brass With Tin Over Nickel Plated
 Applicable PC Board Thickness: 0.8~1.6mm
 Contact Resistance: Initial Value/10mΩ max
 After environmental testing 20mΩ max

B

C



D




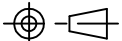
Circuits	Dimension mm		
	A	B	B
2	2.00	7.90	4.60
3	4.00	9.90	6.60
4	6.00	11.90	8.60
5	8.00	13.90	10.60
6	10.00	15.90	12.60
7	12.00	17.90	14.60
8	14.00	19.90	16.60
9	16.00	21.90	18.60
10	18.00	23.90	20.60
11	20.00	25.90	22.60
12	22.00	27.90	24.60
13	24.00	29.90	26.60
14	26.00	31.90	28.60
15	28.00	33.90	30.60
16	30.00	35.90	32.60

Specifications:

Current Rating: 2A AC,DC
 Voltage Rating: 100V AC MAX
 Insulation Resistance 1000MΩ/min
 Temperature Range -25°C~+85°C
 Contact Resistance: 20mΩ Max.
 Dielectric Withstanding Voltage:
 AC 800V for 1 minute

E

1 2 3 4 5 6 7

 易昕企業有限公司 LEAMAX ENTERPRISE CO., LTD.					
PROJ	 SCALE : F DO NOT SCALE DWG		MOLD NO		
APP			MODEL		REV.
CHK	CCJ	92.07.08	FILE NO		X1
DGN	AMY	92.07.08	2.0mm Wire-to-Board		SIZE
DRW	SHIEH	92.07.08	UNIT	SHT 1 OF 1	A4
			MM		

A

B

C

D

E